TOSHIBA Infrared LED GaAs Infrared Emitter

TLN115A(F)

Lead(Pb)-Free Remote-control Systems

- High radiant intensity: IE = 26mW / sr (typ.)
- Wide half-angle value: $\theta 1/2 = \pm 21^{\circ}$ (typ.)
- Excellent radiant—intensity linearity. Modulation by pulse operation and high frequency is possible.
- TPS703(F) pin photodiode with resin to screen out visible light available as detector for remote control

Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Forward current	lF	100	mA	
Forward current derating (Ta > 25°C)	ΔI _F / °C	-1.33	mA / °C	
Pulse forward current (Note 1)	IFP	1	Α	
Reverse voltage	V_{R}	5	V	
Power dissipation	P_{D}	150	mW	
Operating temperature range	T _{opr}	-20~75	°C	
Storage temperature range	T _{stg}	-30~85	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate,

Note 1: Pulse width \leq 100 µs, repetitive frequency = 100 Hz

Unit: mm 7.0 max 7.

Weight: 0.3 g (typ.)

Pin Connection

1. Anode

o → 2 2. Cathode

Optical And Electrical Characteristics (Ta = 25°C)

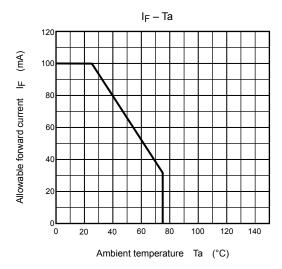
Characteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Forward voltage	V _F	I _F = 100 mA		_	1.35	1.5	V
Reverse current	I _R	V _R = 5 V		_	_	10	μΑ
Radiant intensity	<u></u>	I _F = 50 mA	TLN115A (F)	15	26	_	mW / sr
	ΙE		TLN115A (B,F)	19	_	_	
Radiant power	PO	I _F = 50 mA		_	13	_	mW
Capacitance	C _T	V _R = 0, f = 1 MHz		_	20	_	pF
Peak emission wavelength	λР	I _F = 50 mA		_	950	_	nm
Spectral line half width	Δλ	I _F = 50 mA		_	50	_	nm
Half value angle	$\theta \frac{1}{2}$	I _F = 50 mA		_	±21	_	o

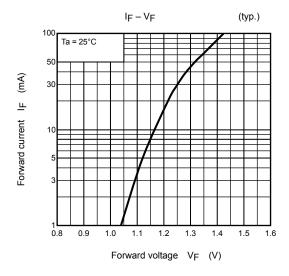
Precautions

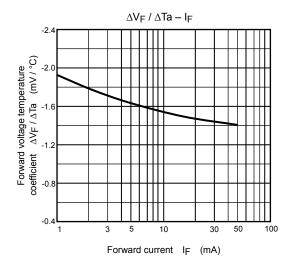
Please be careful of the followings.

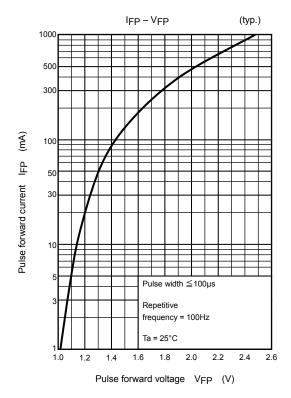
- 1. Soldering must be performed under the stopper.
- 2. Soldering temperature : 260°C max Soldering time : 5 s max
- 3. When forming the leads, bend each lead under the 2 mm from the body of the device. Soldering must be performed after the leads have been formed.
- 4. Radiant intensity falls over time due to the current which flows in the infrared LED. When designing a circuit, take into account this change in radiant power over time. The ratio of fluctuation in radiation intensity to fluctuation in optical output is 1:1.

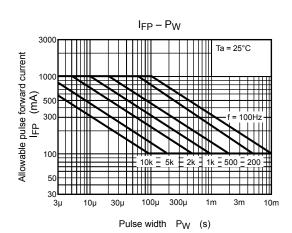
$$\frac{I_{E}(t)}{I_{E}(0)} = \frac{P_{O}(t)}{P_{O}(0)}$$

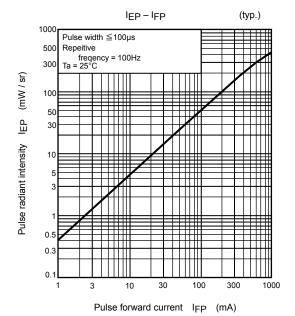


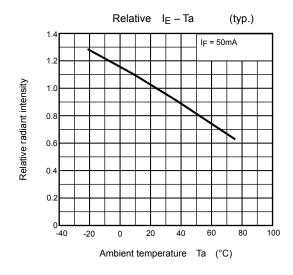


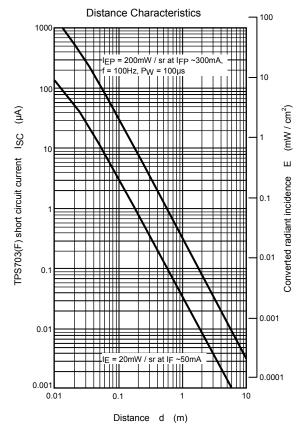


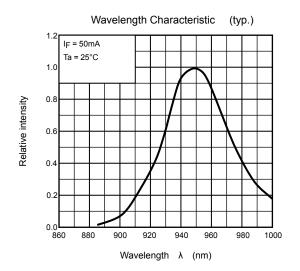


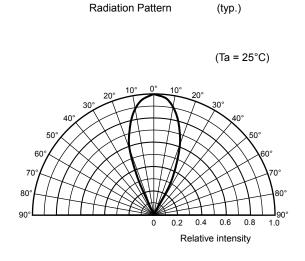












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